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Jameco Part Number 830080

SDLS035A - DECEMBER 1983 - REVISED APRIL 2003

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

#### description

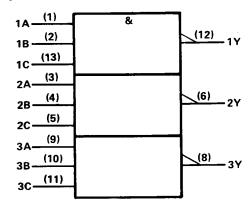
These devices contain three independent 3-input NAND gates.

The SN5410, SN54LS10, and SN54S10 are characterized for operation over the full military temperature range of  $-55\,^{\circ}\text{C}$  to  $125\,^{\circ}\text{C}$ . The SN7410, SN74LS10, and SN74S10 are characterized for operation from  $0\,^{\circ}\text{C}$  to  $70\,^{\circ}\text{C}$ .

**FUNCTION TABLE (each gate)** 

H	NPUT	s	OUTPUT
A	В	С	Y
н	Н	н	Ł
L	X	×	н
X	L	×	н
X	Х	L	н
^	^	٦,	• • •

#### logic symbol†



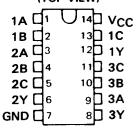
<sup>†</sup>This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, and N packages.

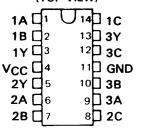
#### positive logic

$$Y = \overline{A \cdot B \cdot C}$$
 or  $Y = \overline{A} + \overline{B} + \overline{C}$ 

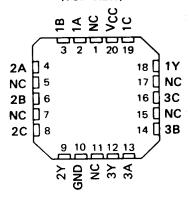
SN5410 . . . J PACKAGE SN54LS10, SN54S10 . . . J OR W PACKAGE SN7410 . . . N PACKAGE SN74LS10, SN74S10 . . . D OR N PACKAGE (TOP VIEW)



SN5410 . . . W PACKAGE (TOP VIEW)

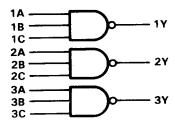


SN54LS10, SN54S10 . . . FK PACKAGE (TOP VIEW)



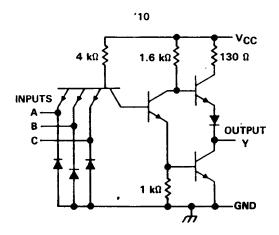
NC - No internal connection

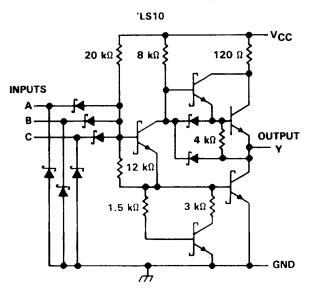
#### logic diagram (positive logic)

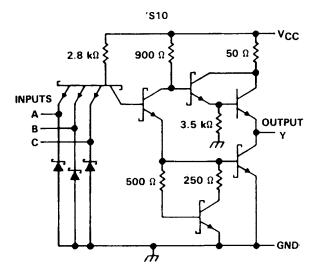




#### schematics (each gate)







Resistor values shown are nominal.

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	7 V
Input voltage: '10, 'S10	5.5 V
'LS10	7 V
Operating free-air temperature range: SN54'	-55°C to 125°C
SN74'	0°C to 70°C
Storage temperature range	-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.



# recommended operating conditions

		SN5410		SN7410			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
V <sub>CC</sub> Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V <sub>IH</sub> High-level input voltage	2			2			V
VIL Low-level input voltage			0.8			0.8	V
IOH High-level output current			- 0.4			- 0.4	mA
IOL Low-level output current			16			16	mA
TA Operating free-air temperature	- 55		125	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDI	TIONS T		SN541	)		SN741	0	
						MAX	MIN	TYP‡	MAX	UNIT
VIK	V <sub>CC</sub> = MIN,	I <sub>I</sub> = - 12 mA				- 1.5			- 1.5	V
VOH	V <sub>CC</sub> = MIN,	V <sub>1L</sub> = 0.8 V,	I <sub>OH</sub> = - 0.4 mA	2.4	3.4		2.4	3.4		V
VOL	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	I <sub>OL</sub> = 16 mA		0.2	0.4		0.2	0.4	V
11	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 5.5 V				1			1	mA
ΉΗ	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.4 V				40			40	μА
IL	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V			-	- 1.6			- 1.6	mA
¹os§	V <sub>CC</sub> = MAX			- 20		- 55	- 18		- 55	mA
Iссн	V <sub>CC</sub> = MAX,	V1 = 0 V			3	6		3	6	mA
<sup>1</sup> CCL	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 4.5 V			9	16.5		9	16.5	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see note 2)

242445750	FROM	то					
PARAMETER	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<sup>t</sup> PLH	A, B or C				11	22	ns
<sup>t</sup> PHL	A, B 01 C	Ť	$R_L = 400 \Omega$ , $C_L = 15 p$	F	7	15	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



<sup>‡</sup> All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C.

<sup>§</sup> Not more than one output should be shorted at a time.

# SN54LS10, SN74LS10, TRIPLE 3-INPUT POSITIVE-NAND GATES

SDLS035 - DECEMBER 1983 - REVISED MARCH 1988

### recommended operating conditions

		SN54LS10		SN74LS10			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	UNII
V <sub>CC</sub> Supply voltage	4.5	5	5.5	4.75	5	5.25	v
V <sub>IH</sub> High-level input voltage	2			2			V
VIL Low-level input voltage			0.7			8.0	V
IOH High-level output current			- 0.4			- 0.4	mA
IOL Low-level output current			4			8	mA
T <sub>A</sub> Operating free-air temperature	<b>– 55</b>		125	0		70	°C

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †			SN54LS	10	İ	SN74LS	S10 ·	
FARAMETER				TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V <sub>CC</sub> = MIN, I <sub>I</sub> = - 18	mA			- 1.5			- 1.5	٧
V <sub>ОН</sub>	V <sub>CC</sub> = MIN, V <sub>IL</sub> = MA	AX, I <sub>OH</sub> = -0.4 mA	2.5	3.4		2.7	3.4		٧
V	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 \	V, I <sub>OL</sub> = 4 mA		0.25	0.4			0.4	
VOL	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 \	V, I <sub>OL</sub> = 8 mA					0.25	0.5	\ \
l <sub>1</sub>	V <sub>CC</sub> = MAX, V <sub>I</sub> = 7 V				0.1			0.1	mA
ЧН	V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V	V			20			20	μΑ
IιΓ	V <sub>CC</sub> = MAX, V <sub>1</sub> = 0.4	V		-	- 0.4			- 0.4	mA
los§	V <sub>CC</sub> = MAX		- 20		- 100	- 20		- 100	mA
Іссн	V <sub>CC</sub> = MAX, V <sub>I</sub> = 0 V			0.6	1.2		0.6	1.2	mΑ
ICCL	V <sub>CC</sub> = MAX, V <sub>1</sub> = 4.5 V	V		1.8	3.3		1.8	3.3	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

### switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
tPLH	A, B or C	Y	$R_1 = 2 k\Omega$ , $C_1 = 15 pF$		9	15	ns
<sup>t</sup> PHL		·			10	15	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ . § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

#### recommended operating conditions

			SN54S10		SN74S10			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	וואט
vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	٧
ЮН	High-level output current			<b>– 1</b>			- 1	mA
loL	Low-level output current		·	20			20	mA
TA	Operating free-air temperature	- 55		125	0		70	°c

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEAT 001101	rious t		SN54S1	0		SN74S	10	UNIT
FARMINETER		TEST CONDITIONS †			TYP‡	MAX	MIN	TYP‡	MAX	UNIT
v <sub>IK</sub>	V <sub>CC</sub> = MIN,	I <sub>I</sub> = -18 mA				-1.2			-1.2	٧
V <sub>OH</sub>	V <sub>CC</sub> ≈ MIN,	V <sub>IL</sub> = 0.8 V,	I <sub>OH</sub> = - 1 mA	2.5	3.4		2.7	3.4		٧
V <sub>OL</sub>	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	I <sub>OL</sub> = 20 mA			0.5			0.5	V
l <sub>l</sub>	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 5.5 V				1			1	mA
IIH	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 2.7 V				50			50	μА
†IL	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 0.5 V				<b>–2</b>			-2	mA
IOS§	V <sub>CC</sub> = MAX			-40		-100	<b>-40</b>	·	-100	mA
Iссн	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 0 V			7.5	12		7.5	12	mA
<sup>1</sup> CCL	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 4.5 V	,		15	27		15	27	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

### switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONE	DITIONS	MIN	TYP	MAX	UNIT
<sup>t</sup> PLH			R <sub>L</sub> = 280 Ω,	C <sub>1</sub> = 15 pF		3	4.5	ns
<sup>t</sup> PHĿ	A D . O	V	NL - 200 12,	CL - 19 PF		3	5	ns
<sup>t</sup> PLH	A, B or C	Y	D 200 O	C = 50 = 5		4.5		ns
<sup>t</sup> PHL			R <sub>L</sub> = 280 Ω,	CL = 50 pF		5		ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ . § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.



#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
JM38510/00103BCA	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
JM38510/00103BDA	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI
JM38510/07005BCA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/07005BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
JM38510/30005B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
JM38510/30005BCA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/30005BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
JM38510/30005SCA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/30005SDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
SN5410J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN54LS10J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S10J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
SN7410N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN7410N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN7410NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS10D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS10DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS10DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS10DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS10N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS10N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74LS10NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS10NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS10NSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S10D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S10DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S10N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S10N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74S10NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74S10NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S10NSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM



#### PACKAGE OPTION ADDENDUM

18-Jul-2006

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins I	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SNJ5410J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SNJ5410W	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI
SNJ5410WA	OBSOLETE	CFP	WA	14		TBD	Call TI	Call TI
SNJ54LS10FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS10J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS10W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
SNJ54S10FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54S10J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54S10W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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### 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# W (R-GDFP-F14)

### CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



#### FK (S-CQCC-N\*\*)

#### **28 TERMINAL SHOWN**

#### **LEADLESS CERAMIC CHIP CARRIER**



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



### N (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



# D (R-PDSO-G14)

### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AB.



#### **MECHANICAL DATA**

### NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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